

## **Industrial Vertical Hot Air Curing Oven For PCBA Electronics**

## **Basic Information**

. Place of Origin: China Brand Name: GS

KT-400/KT-280 Model Number:

1 PCS . Minimum Order Quantity:

• Price: USD+negotiable+pcs 2700\*1800\*2500mm Packaging Details:

Delivery Time: 1-7 days • Payment Terms: T/T

Supply Ability: 1+pcs+per days



## **Product Specification**

Model: KT-400/KT-280

• Applicable Production PCBA Curing Production After Product

Range:

2500(L)x1740(w)x2240(H)/2500(L)x1580(w)x2450(H) • Dimensions (mm):

Weight(Kg): Approx. 1800/1650 Heating Time: Approx.30minute Temperature Setting Room Temp.180

Range:

Temperature Control

Accuracy:

Control Method: PID Closed-loop Control + SSR Drive +

≤±3.0°C

±1.0°C

Touch Screen

PCB Board Temperature

Distribution Deviation:

Furnace Time: According To Product Demand Parameter

Setting

· Highlight: Vertical Hot Air Curing Oven,

## **Product Description**

- 1.Significantly to saving labor compared to the offline curing oven, the machine has automatic entry and exit, completely eliminating the manual removal of the offline curing oven.
- 2.Improve the curing quality compared to the offline curing furnace, without the manual handling of the product when opening and closing the furnace action, the furnace temperature is more stable, the product quality is better.
- 3.Significantly reduce the occupation of the ground compared to the horizontal transport mode of the tunnel furnace or the conventional SMT reflow oven, the vertical furnace footprint of the same capacity is reduced several times or even ten times 4.Improve energy efficiency Compared with the horizontal transport mode tunnel furnace or conventional SMT reflow oven, make full use of the basic principle of hot air upward movement, more fully utilized thermal energy



발号 Model	KT-400 / KT-280	备注 Note
適用生产范围 Applicable production range	PCBA产品涂覆后固化生产 PCBA Curing production after product coating	
外型尺寸 Dimensions(mm)	2500(L)×1740(W)×2240(H) 2500(L)×1580(W)×2450(H)	机台高度与重量会依客户订制层数要求增加而增加 The height and weight of the machine bed will increase according to the requirements of the custom layer
重量 Weight(kg)	Approx. 1800 / 1650	
升温时间 Heating time	Approx.30minute	
温度设定范围 Temperature setting range	室温180℃ Room Temp.180℃	
温度控制精度 Temperature control accuracy	±2.0°C	
控制方式 Control method	PID闭环控制+SSR驱动+触摸屏 PID closed-loop control+ SSR drive+ touch screen	
PCB板温分布偏差 PCB board temperature distribution deviation	±2.0°C	
过炉时间 Furnace time	依产品需求参数设定 According to product demand parameter setting	
PCB 最大尺寸 PCB maximum size(mm)	400(L)×400(W) 300(L)×280(W)	小板可采用过炉托盘,非标尺寸可定制 Small plates can be used by curing trays, non standard size can be Customized
导轨调宽范围 Rail width adjustment range	100~400mm	
过板空间 Board space	PCB上部空间=25.4mm-板原-板下元件高度 PCB upper space = 25.4mm plate thickness - under the component height	可定制25.4的整数倍的托板间距或其它规格的链条, 依链条规格的不同板上空间会有不同 Can be customized with an integral multiple of 25.4 pallet spacing or other specifications of the chain, depending on the size of the chain, the board space will be different
运输高度 Transmission height(mm)	900±20mm	参照客户点胶设备 Reference customer dispensing equipment

Vertical Hot Air Curing Oven | GSSMT, Vertical hot air curing oven, Vertical curing oven for electronics, Hot air vertical curing system, Vertical curing oven for PCB, Industrial vertical curing oven, Vertical hot air oven for curing, Vertical hot air curing machine, PCB vertical curing oven, High-temperature vertical curing oven, Vertical hot air oven for coating, Vertical curing oven SMT, Hot air curing oven for electronics, Industrial hot air curing oven, Vertical hot air curing equipment, Hot air curing oven for PCB, Vertical curing oven with hot air, Compact vertical curing oven, Vertical hot air curing furnace, Vertical hot air oven for adhesive curing, Vertical hot air curing chamber



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